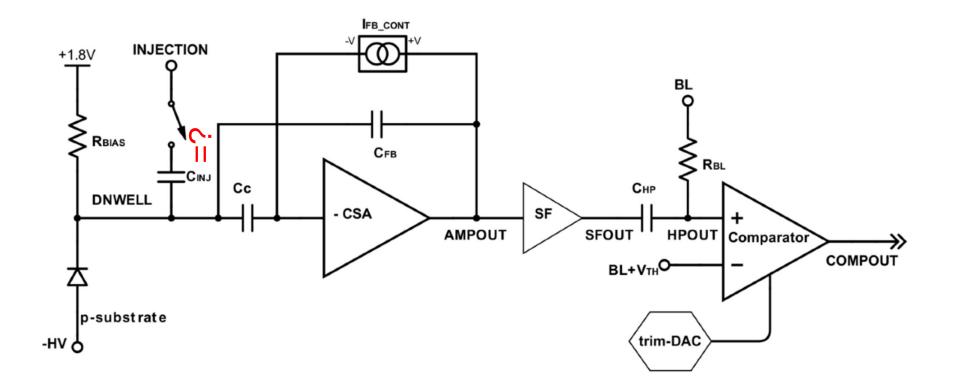


Problems with unknown capacitance for irradiated sensors



RD50 Group Meeting

Clarification

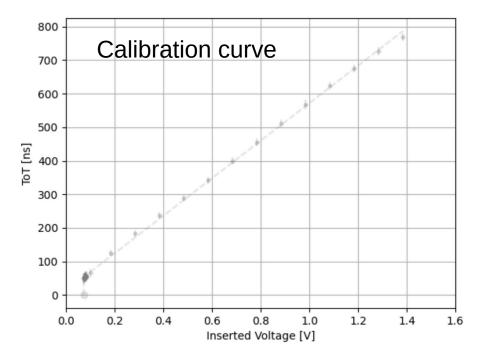
- When talking about issues for irradiated sensors, I DO NOT mean
 - That I think that radiation damage varies the capacitance of the injection capacitor
 - That it hinders basic operation of the sensors
- I **DO** mean
 - That evaluating the effect of radiation damage on the sensor is severely hindered



Problems with varying capacitance with the MP4

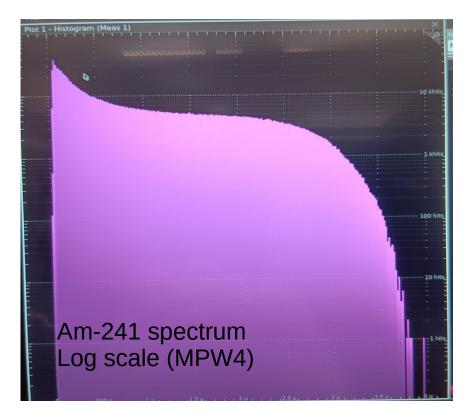
- Allows for a known voltage (charge if capacitance is known) \rightarrow ToT response curve
- Calibration of charge capacitor typically done using radioactive source
 - Preferably Fe-55 or Am-241 due to distinct peaks

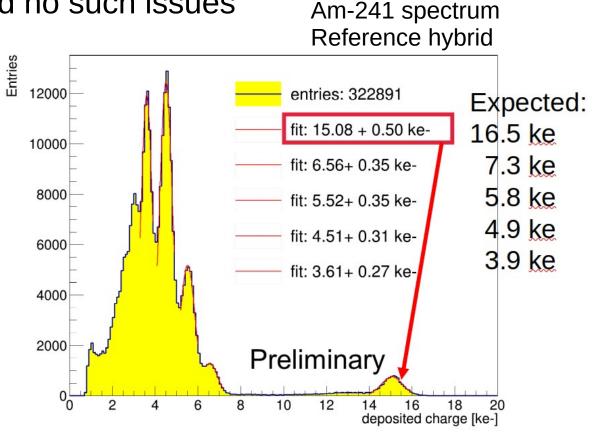
C_inj is a Varactor not metal traces laying over one another (also true for C_fb?)



Measuring capacitance

- Fe-55 is not possible as Q_Fe55 < Q_threshold
- Am-241 is not possible as we cannot discern any peaks (noise?)
 - A different sensor (200 micron hybrid) had no such issues

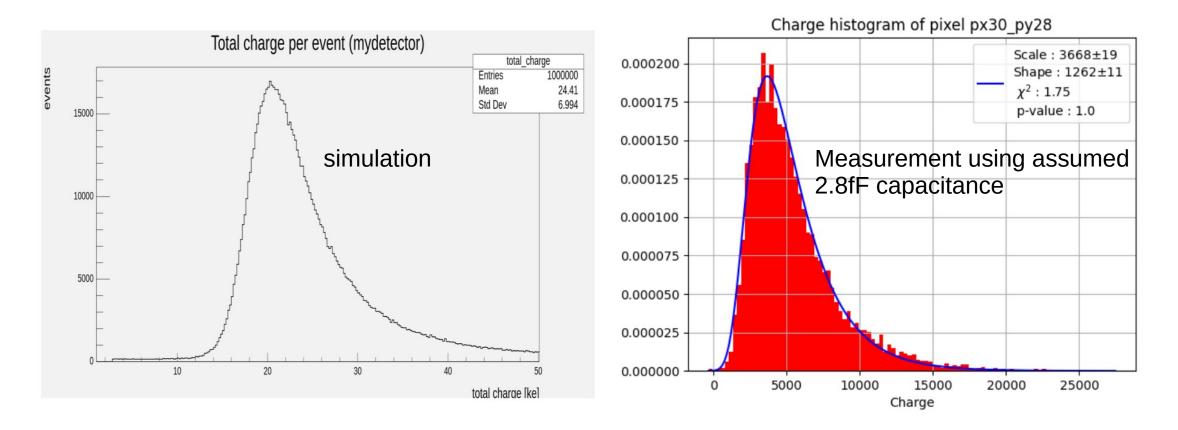




Nik hef

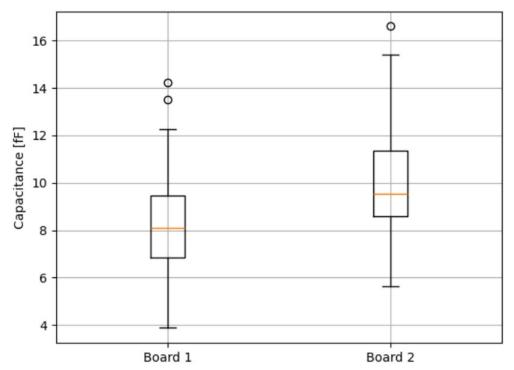
Measuring capacitance

- Alternative is using Sr90 using the MPV basing it on MIP deposition
- The ratio of seen charge to expected charge gives the "true" capacitance
- This works only because we make the assumption that we see all charge



We make the assumption charge is 20ke-

- The whole basis on which we determine the capacitor is the assumption that we collect 100% of the expected charge
- With this assumption we can see the capacitance in the same board, pixel-pixel varies by up to a factor 3.5
- This assumption does NOT work for irradiated sensors
- At some level we will see charge loss due to
 - trapping
 - insufficient depletion



From Andres presentation last week



Conclusion

- When operating with irradiated chips we have one equation with two unknowns
 - The injection capacitance
 - The amount of collected charge
 - \rightarrow Not possible to determine the true performance
- One possibility is to see if other monochromatic sources of charge beyond Fe-55 instead of Am-241 work (x-ray fluorescence for example, but that requires a lot of setup)
- Another possibility is to irradiate already bonded chips on boards, however that means a lot of irradiated material meaning the system is very "hot"

